

IFW

Docket No.: X2007.0137  
(PATENT)

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Patent Application of:  
Fumiaki Sasaki et al.

Application No.: 10/653,352

Confirmation No.: 3035

Filed: August 28, 2003

Art Unit: 1742

For: HIGH STRENGTH COPPER ALLOY AND  
MANUFACTURING METHOD  
THEREFOR

Examiner: Not Yet Assigned

**REQUEST FOR CORRECTED FILING RECEIPT**

Filing Receipt Corrections  
Office of Initial Patent Examination  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

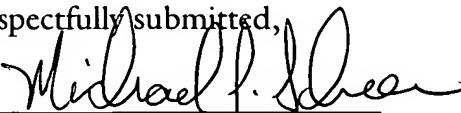
Applicant hereby requests that a corrected Filing Receipt be issued in the above-identified patent application. The official Filing Receipt received by Applicant, a copy of which is attached hereto, has an error in Filing Date of the application.

The application was hand-delivered to the U.S. Patent and Trademark Office on August 28, 2004. However, the Filing Receipt indicates a filing date of September 2, 2004. We are enclosing a postcard, date stamped, indicating August 28, 2004 as the date in which the application was received into the Office of Initial Patent Examination.

Applicant additionally requests that all pertinent U.S. Patent and Trademark Office records relating to the subject application be changed to reflect this correction.

Dated: June 3, 2004

Respectfully submitted,

By 

Michael J. Scheer

Registration No.: 34,425

DICKSTEIN SHAPIRO MORIN &  
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Attorney for Applicant



## UNITED STATES PATENT AND TRADEMARK OFFICE

UNITED STATES DEPARTMENT OF COMMERCE  
United States Patent and Trademark Office  
Address: COMMISSIONER FOR PATENTS  
P.O. Box 1450  
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| APPL NO.   | FILING OR 371<br>(c) DATE | ART UNIT | FIL FEE REC'D | ATTY. DOCKET NO | DRAWINGS | TOT CLMS | IND CLMS |
|------------|---------------------------|----------|---------------|-----------------|----------|----------|----------|
| 10/653,352 | 09/02/2003<br>08/28/0003  | 1742     | 1030          | X2007.0137      | 6        | 6        | 2        |

CONFIRMATION NO. 3035

## FILING RECEIPT



\*OC000000011346722\*

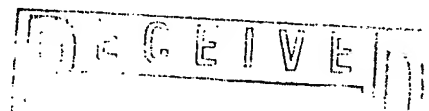
32172  
DICKSTEIN SHAPIRO MORIN & OSHINSKY LLP  
1177 AVENUE OF THE AMERICAS (6TH AVENUE)  
41 ST FL.  
NEW YORK, NY 10036-2714

Date Mailed: 11/24/2003

Receipt is acknowledged of this regular Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Filing Receipt Corrections, facsimile number 703-746-9195. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

## Applicant(s)

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Yozo Tsugane, Asaba-cho, JAPAN;



## Domestic Priority data as claimed by applicant

## Foreign Applications

JAPAN 2002-255937 08/30/2002 ✓



If Required, Foreign Filing License Granted: 11/24/2003

Projected Publication Date: 03/04/2004

Non-Publication Request: No

Early Publication Request: No

DEMO FILE NO. X2007.0137  
D/E: \_\_\_\_\_  
C/L: \_\_\_\_\_  
ENTERED BY: HM  
ATTY: SLW

## Title

High strength copper alloy and manufacturing method therefor

## Preliminary Class

420

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Title 35, United States Code, Section 184  
Title 37, Code of Federal Regulations, 5.11 & 5.15**

**GRANTED**

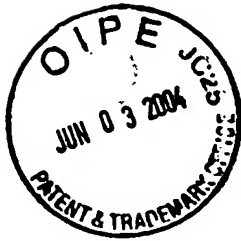
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**Atty Docket No.:** X2007.0137

**Inventor:** Fumiaki Sasaki, et al.

**Application No.:** Not Yet Assigned

**Filing Date:** Concurrently Herewith

**Title:** HIGH STRENGTH COPPER ALLOY AND MANUFACTURING METHOD THEREFOR

**Documents Filed:**

Fee Transmittal (1 page)

Recordation Form Cover Sheet (1 page)

Utility Patent Application Transmittal (1 page)

Assignment (3 pages)

Specification (16 pages)

Information Disclosure Statement (3 pages)

6 drawings (6 sheets)

DS Citation (1 page)

Oath or declaration (4 pages)

Copies of Information Disclosure Citations

Claim for Priority and Submission of Documents (2 pages)

Payment by credit card. Form PTO-2038 is attached (1 page)

Certified copy of Priority document JP 2002-255937

Charge \$1,070.00 to credit card

**Via:**

**Sender's Initials:** SIW/MJT/djp

468-2803

**Date:** August 28, 2003